



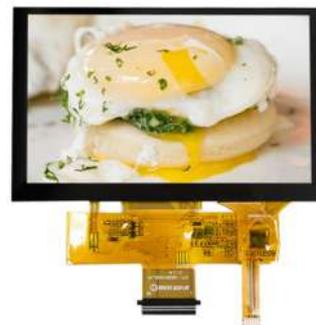
ORIENT DISPLAY

Your Total LCD Solution Provider

Specification for TFT

AFY800480B1-5.0N12NTM-C

Revision A



A	Orient Display
FY	TFT Type
800480	Resolution 800 x 480
B1	Serial B1
5.0	5.0", Module Dimension 120.70 x 75.80 x 5.10 mm
N	TN Display
12	12 O'clock
N	Top: -20~+70°C; Tstr: -30~+80°C
T	Transmissive
M	Medium Brightness, 400 cd/m ²
C	Capacitive Touch Panel
/	ILI6122+ILI5960 OR COMPATIBLE(TFT) MXT336T(CTP)
/	RGB 24bit interface(TFT)/I2C(CTP)



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1. GENERAL INFORMATION

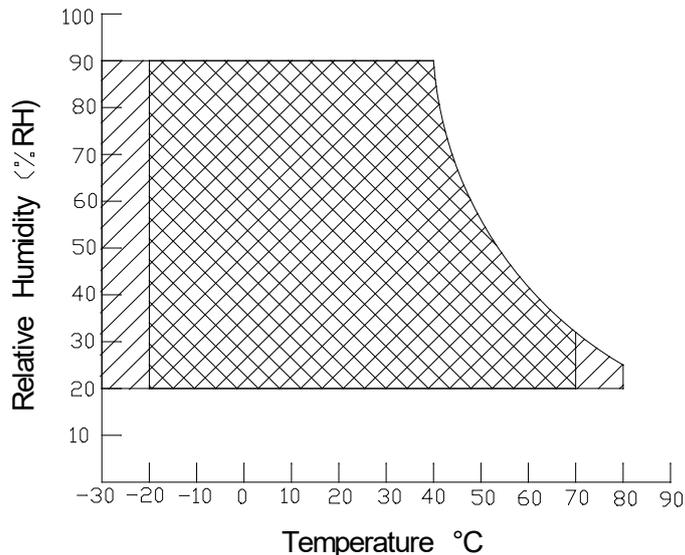
No.	Item	Contents	Unit
1	LCD size	5.0 inch (Diagonal)	/
2	Display mode	a-Si TFT&CTP TN/Normally white/Transmissive	/
3	Viewing direction(eye)	12 O'clock	/
4	Gray scale inversion direction	6 O'clock	/
5	Resolution(H*V)	800 *480 Pixels(TFT)/ 800 *480 Dots(CTP)	/
6	Module size (L*W*H)	120.70*75.80*5.10	mm
7	Active area (L*W)	108.00*64.80	mm
8	Pixel pitch (L*W)	0.135*0.135	mm
9	Interface type	RGB 24bit interface(TFT)/I2C(CTP)	/
10	Color Depth	16.7M	/
11	Module power consumption	1.272	W
12	Back light type	LED	/
13	Driver IC	ILI6122+ILI5960 OR COMPATIBLE(TFT) MXT336T(CTP)	/
14	Weight	92.3	G

2. ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Min.	Max.	Unit	Note
Power supply input voltage for TFT	VDD	-0.3	5.0	V	
Power supply input voltage for CTP	VDD	-0.3	3.6	V	
Backlight current (normal temp.)	ILED	-	50	mA	
Operation temperature	Top	-20	+70	°C	Note1
Storage temperature	Tst	-30	+80	°C	Note1
Humidity	RH	20%	90%	/	Note1

Note1 :

- 1).The relative humidity and temperature range are as below sketch,90%RH Max.
- 2).The maximum wet bulb temperature $\leq 40^{\circ}\text{C}$ and without dewing.



Operating Range  Storage Range  + 

3. ELECTRICAL CHARACTERISTICS

TFT DC CHARACTERISTICS(at Ta=25°C)

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Power supply input voltage	VDD	3.0	3.3	3.6	V	
I/O logic voltage	VDDIO	-	-	-	V	
Input voltage 'H' level	VIH	0.7VDDIO	-	VDDIO	V	
Input voltage 'L' level	VIL	VSS	-	0.3VDDIO	V	
Power supply current	IVDD	-	160	-	mA	
TFT gate on voltage	VGH	-	-	-	V	
TFT gate off voltage	VGL	-	-	-	V	
Analog power supply voltage	AVDD	-	-	-	V	
Differential input common mode voltage	Vcom	-	-	-	V	Note1

Note1 : The value is just the reference value. The customer can optimize the setting value by the different D-IC
Vcom must be adjusted to optimize display quality, as Crosstalk and Contrast Ratio etc..

CTP DC CHARACTERISTICS(at Ta=25°C)

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Power supply input voltage	VDD	2.7	3.3	3.47	V	Note2
Input Power ripple	Vpp	-	-	50	mV	
I/O Signal Voltage	VDDIO	-	VDD	-	V	Note2
Input voltage 'H' level	VIH	0.7IVDDIO	-	VDDIO	V	
Input voltage 'L' level	VIL	VSS	-	0.3VDDIO	V	
Operating Current (Normal Mode)	IVDD	-	TBD	-	mA	
Operating Current (Sleep mode)	IVDD	-	TBD	-	mA	

Note1 : If you need more information of CTP, please refer to our Spec of CTP.

4. BACKLIGHT CHARACTERISTICS

(at Ta=25°C, RH=60%)

Item	Symbol	Min.	Typ.	Max.	Unit	Note
LED forward voltage	VF	17.2	18.6	19.8	V	
LED forward current	IF	-	40	-	mA	IF=20*2mA
LED power consumption	PLED	-	0.744	-	W	Note1
Number of LED	-		12		PCS	
Connection mode	-	6 in series 2 in parallel			/	
LED life-time	-	20000	-	-	Hrs	Note2

Note1 : Calculator value for reference : IF*VF = PLED

Note2 : The LED life-time define as the estimated time to 50% degradation of initial brightness at Ta=25°C and IF =40mA. The LED lifetime could be decreased if operating IF is larger than 40mA.

5. TOUCH PANEL CHARACTERISTICS

(at Ta=25°C)

Item	Description	Remark
Product Structure	G+G	
Surface Hardness	≤6H	Pencil, Loading 500g, 45 deg
Ball-falling Test	≤80cm	Steel ball weight 64g
Touch Count Max	5 point	
I2C Slave Address*	0x4A	
Origin of Coordinate*	Top left corner	
FW version	0x2099AB	

7. ELECTRO - OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	Remark	Note
Response time	Tr+ Tf	-	-	25	50	ms	FIG.1	Note 1
Contrast ratio	Cr		400	500	-	-	FIG.2	Note 2
Surface luminance	Lv	$\theta=0^\circ$	350	400	-	cd/m ²	FIG.2	Note 3
Luminance uniformity	Yu	$\theta=0^\circ$	75	80	-	%	FIG.2	Note 4
NTSC	-	$\theta=0^\circ$	-	50	-	%	FIG.2	Note 5
Viewing angle	θ	$\varnothing=90^\circ$	60	70	-	deg	FIG.3	Note 6
		$\varnothing=270^\circ$	40	50	-	deg	FIG.3	
		$\varnothing=0^\circ$	60	70	-	deg	FIG.3	
		$\varnothing=180^\circ$	60	70	-	deg	FIG.3	
CIE (x,y) chromaticity	Red x	$\theta=0^\circ$ $\varnothing=0^\circ$ Ta=25°C	Typ -0.04	0.55	Typ +0.04	-	FIG.2 CIE1931	Note 5
	Red y			0.33		-		
	Green x			0.34		-		
	Green y			0.60		-		
	Blue x			0.15		-		
	Blue y			0.09		-		
	White x			0.31		-		
	White y			0.34		-		

Note1. Definition of response time

The response time is defined as the LCD optical switching time interval between “White” state and “Black”state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%. For additional information see FIG1.

Note2. Definition of contrast ratio

Contrast ratio(Cr) is defined mathematically by the following formula. For more information see FIG.2.

$$\text{Contrast ratio} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Measured at the center area of the LCD

Note3. Definition of surface luminance

Surface luminance is the luminance with all pixels displaying white. For more information see FIG.2.

Lv = Average Surface Luminance with all white pixels(P1,P2,P3,,Pn)

Note4. Definition of luminance uniformity

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance. For more information see FIG.2.

$$Y_u = \frac{\text{Minimum surface luminance with all white pixels (P1,P2,P3,.....,Pn)}}{\text{Maximum surface luminance with all white pixels (P1,P2,P3,.....,Pn)}}$$

Note5. Definition of color chromaticity (CIE1931)

CIE (x,y) chromaticity, The x,y value is determined by screen active area center position P5. For more information see FIG.2.

Note6. Definition of viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10. angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG.3.

For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope or DMS series Instruments or compatible. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on TOPCON's BM-5or BM-7 photo detector or compatible.

FIG.1. The definition of response Time

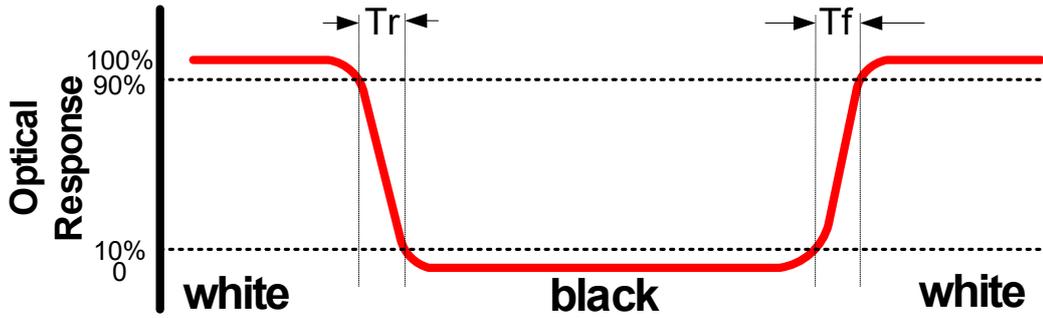


FIG.2. Measuring method for contrast ratio, surface luminance, luminance uniformity, CIE (x,y) chromaticity

H,V : Active area

Light spot size $\varnothing=5\text{mm}$ (BM-7)50cm distance or compatible distance from the LCM surface to detector lens.

Test spot position : see Figure a.

measurement instrument : TOPCON's luminance meter BM-7 or compatible ,see Figure b.

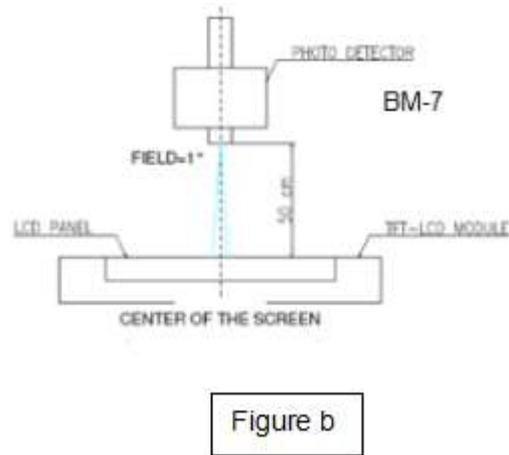
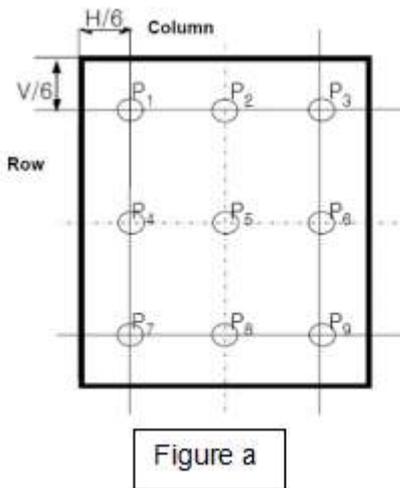
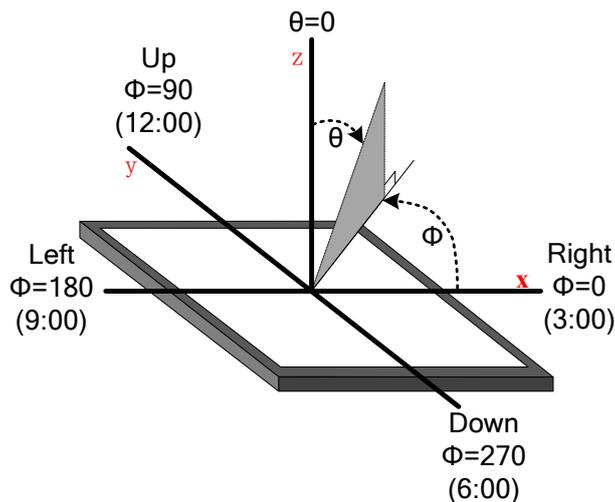


FIG.3. The definition of viewing angle



8. INTERFACE DESCRIPTION

TFT Module Interface description

Interface No.	Name	I/O or connect to	Description
1	LEDK	P	Power for LED backlight(Cathode)
2	LEDA	P	Power for LED backlight(Anode)
3	CS(NC)	/	/
4	VDD	P	Power for LCD
5-12	Red(0-7)	I	Red data
13-20	Green(0-7)	I	Green data
21-28	Blue(0-7)	I	Blue data
29	GND	P	Ground
30	DCLK	I	Dot clock
31	DISP	I	Display on/off
32	HSYNC	I	Horizontal sync input.
33	VSYNC	I	Vertical sync input
34	DE	I	Data enable
35	SCL(NC)	/	/
36	SDA(NC)	/	/
37	XR/NC	/	/
38	YD/NC	/	/
39	XL/NC	/	/
40	YU/NC	/	/

CTP interface description

Interface No.	Name	I/O or connect to	Description
1	GND	P	Ground
2	CHG INT	I	State change interrupt
3	RESET	I	Reset low
4	VDD	P	Power Supply of CTP
5	SCL	I	Serial interface clock
6	SDA	I/O	Serial interface date

9. AC CHARACTERISTICS

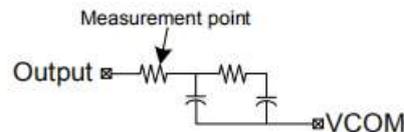
TFT Module AC CHARACTERISTICS

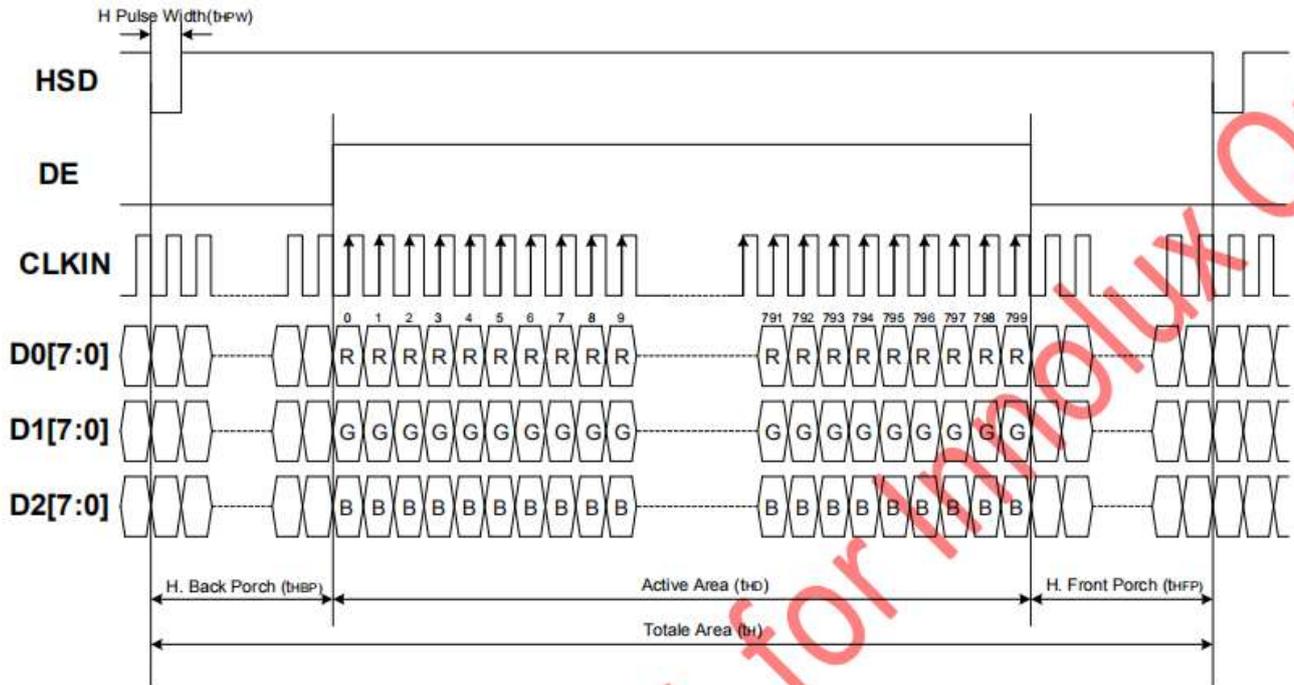
Parameter	Symbol	Spec			Unit	Conditions
		Min.	Typ.	Max.		
VDD Power ON slew rate	t_{POR}	--	--	20	ms	0V ~ 0.9VDD
RSTB pulse width	t_{RST}	10	--	--	us	CLKIN=50MHz
CLKIN cycle time	t_{CPH}	20	--	--	ns	
CLKIN pulse duty	t_{CWH}	40	50	60	%	
VSD setup time	t_{VST}	8	--	--	ns	
VSD hold time	t_{VHD}	8	--	--	ns	
HSD setup time	t_{HST}	8	--	--	ns	
HSD hold time	t_{HHD}	8	--	--	ns	
Data setup time	t_{DST}	8	--	--	ns	D0[7:0], D1[7:0], D2[7:0] to CLKIN
Data hold time	t_{DHD}	8	--	--	ns	D0[7:0], D1[7:0], D2[7:0] to CLKIN
DE setup time	t_{EST}	8	--	--	ns	
DE hold time	t_{EHD}	8	--	--	ns	
Output stable time	t_{SST}	--	--	6	us	10% to 90% target voltage. CL=120pF, R=10K Ω
CLKIN frequency	f_{CLK}	--	40	50	MHz	VDD=3.0 ~ 3.6V
CLKIN cycle time	t_{CLK}	20	25	--	ns	
CLKIN pulse duty	t_{CWH}	40	50	60	%	T_{CLK}
Time from HSD to Source output	t_{HSO}	--	20	--	CLKIN	
Time from HSD to LD	t_{HLD}	--	20	--	CLKIN	Note (2)
Time from HSD to STV	t_{HSTV}	--	2	--	CLKIN	
Time from HSD to CKV	t_{HCKV}	--	20	--	CLKIN	
Time from HSD to OEV	t_{HOEV}	--	4	--	CLKIN	
LD pulse width	t_{WLD}	--	10	--	CLKIN	Note (2)
CKV pulse width	t_{WCKV}	--	66	--	CLKIN	
OEV pulse width	t_{WOEV}	--	74	--	CLKIN	

Note: (1) VDD=3.0 ~ 3.6V, VDDA=6.5~13.5V, DGND=AGND=0V, Ta=-20~+85 °C

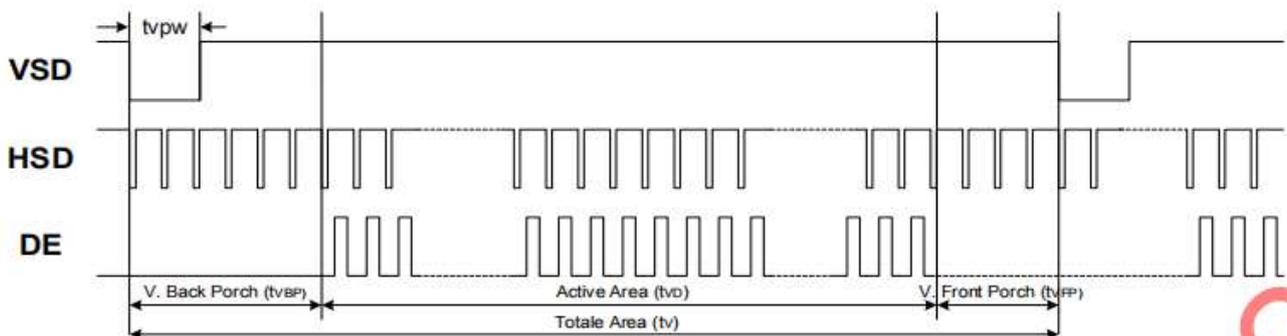
(2) The contents of the data register are transferred to the latch circuit at the rising edge of LD. Then the gray scale voltage is output from the device at the falling edge of LD.

(3) Output loading condition :





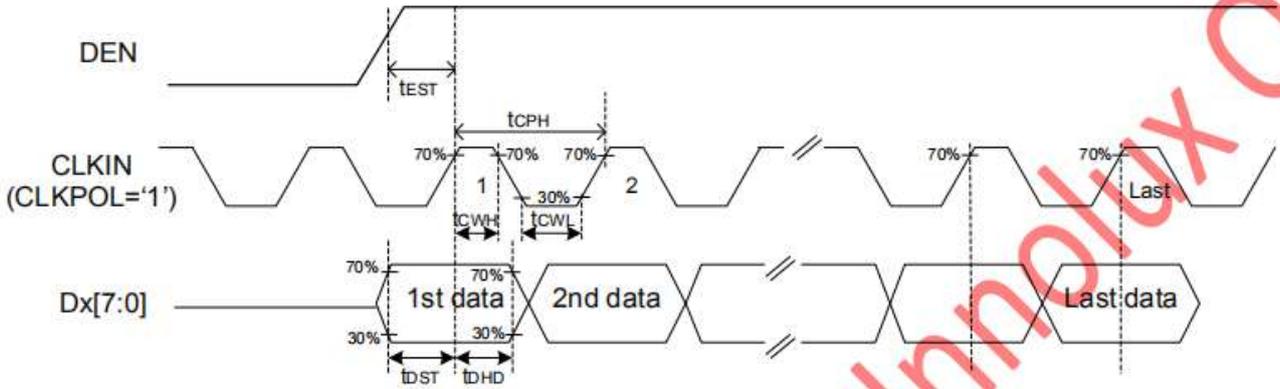
Horizontal Input Timing						
Parameter	Symbol	Value			Unit	
		Min.	Typ.	Max.		
Horizontal display area	t _{HD}	--	800	--	CLKIN	
CLKIN frequency	f _{CLK}	--	33.3	50	MHz	
1 Horizontal line period	t _H	862	1056	1200	CLKIN	
HSD pulse width	t _{HPW}	Min.	--	1	CLKIN	
		Typ.	--	--	CLKIN	
		Max.	--	40	CLKIN	
HSD back porch	SYNC	t _{HBP}	46	46	46	CLKIN
HSD front porch	SYNC	t _{HFP}	16	210	354	CLKIN



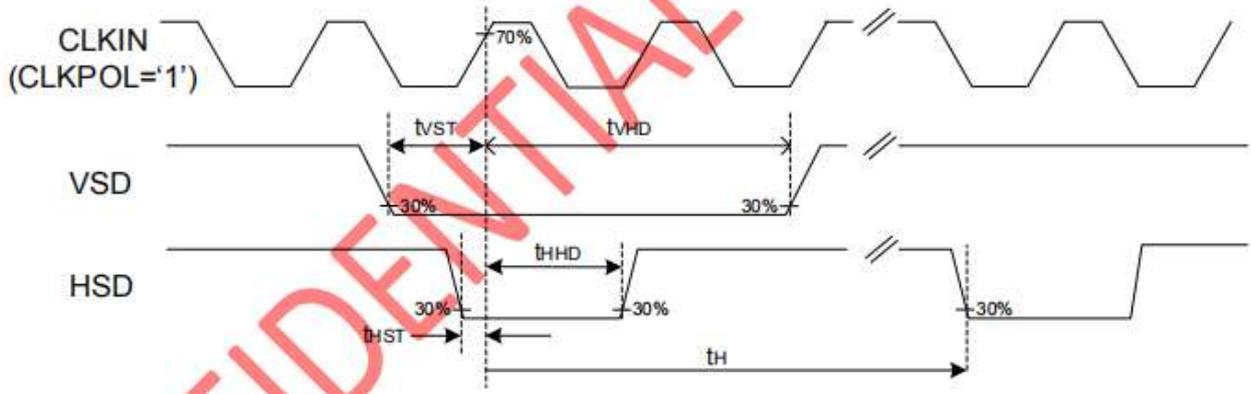
Vertical Input Timing					
Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
Vertical display area	t _{VD}	--	480	--	HSD
VSD period time	t _V	510	525	650	HSD
VSD pulse width	t _{VPW}	1	--	20	HSD
VSD back porch	t _{VBP}	23	23	23	HSD
VSD front porch	t _{VFP}	7	22	147	HSD

AC Timing characteristics

DE Mode (MODE='1')



SYNC Mode (MODE='0')



10. POWER SEQUENCE

TFT Module POWER SEQUENCE

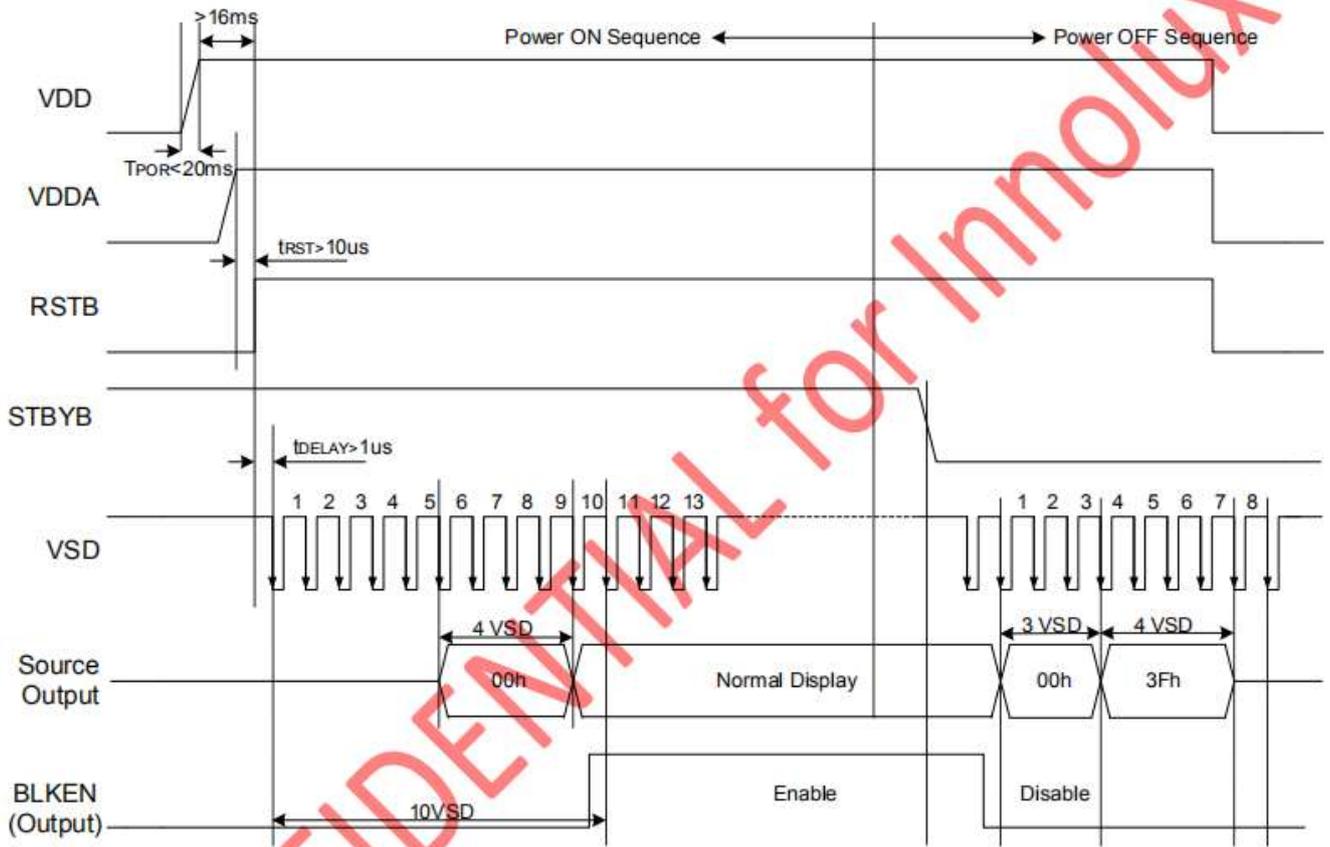
To prevent the device damage from latch up and improve subjective display effect, the power ON/OFF sequence shown below must be followed.

To prevent the device damage from latch up, the power ON/OFF sequence shown below must be followed.

Power ON: VDD, DGND → VDDA, AGND → V1 to V14

Power OFF: V1 to V14 → VDDA, AGND → VDD, DGND

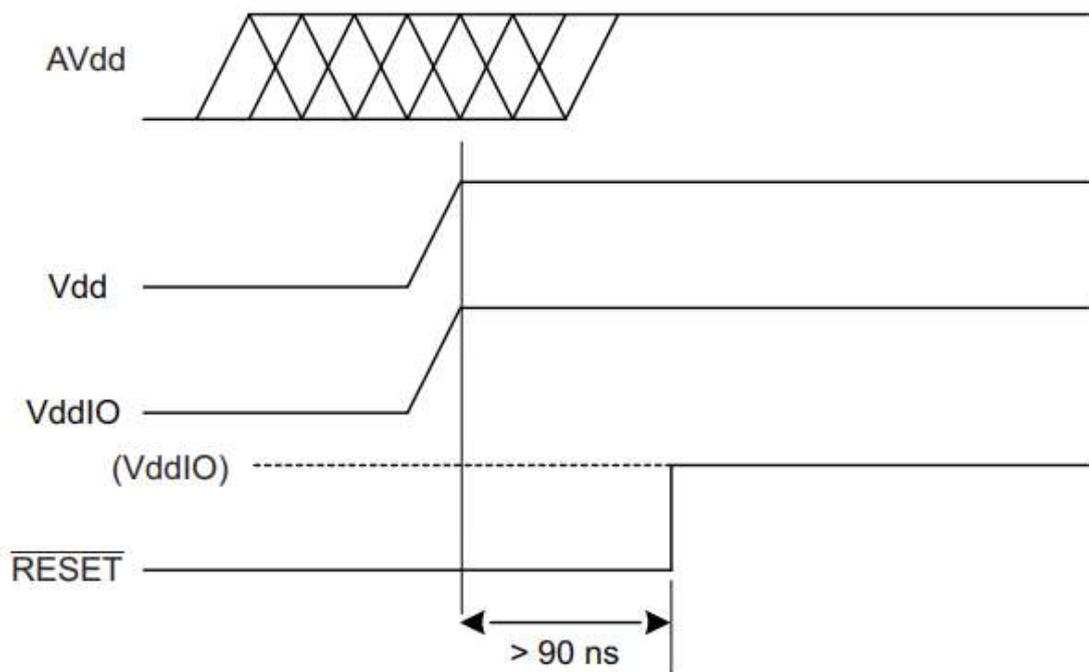
In order to prevent ILI6122 from power ON reset fail, the rising time (t_{POR}) of the digital power supply VDD should be maintained within given specifications. The power ON/OFF timing sequence is illustrated as below:



Note: For prevent anomalous operation, t_{RST} must be longer than $10\mu\text{s}$ during Power ON sequence.

CTP POWER SEQUENCE

Power Sequencing on the mXT336T



Note: When using external $\overline{\text{RESET}}$ at power-up, VddIO must not be enabled after Vdd

11. RELIABILITY TEST CONDITIONS

No.	Test item	Test condition	Inspection after test	
11.1	High temperature storage test	+80°C/240 hours	Inspection after 2~4hours storage at room temperature, the sample shall be free from defects : 1.Current changing value before test and after test is 50% larger; 2. Function defect : Non-display,abnormal-d isplay,missing lines, Short lines,I/O corrosion; 3.Visual defect : Air bubble in the LCD,Seal leak,Glass crack.	
11.2	Low temperature storage test	-30°C/240 hours		
11.3	High temperature operating test	+70°C/120 hours		
11.4	Low temperature operating test	-20°C/120 hours		
11.5	Temperature cycle storage test	-30°C ~ 25°C ~ +80°C/10cycles (30min.) (10min.) (30min.)		
11.6	High temperature high humidity test	+50°C*90% RH/120 hours		
11.7	Vibration test	Frequency : 250 r/min Amplitude : 1 inch Time: 45min		
11.8	Drop test	Drop direction: 1 corner/3 edges/6 sides 10 times		
		Packing weight(kg)		Drop height(cm)
		<11		80±1.6
		11≤G<21	60±1.2	
		21≤G<31	50±1.0	
11.9	ESD test	31≤G<40		
		40±0.8		
Air discharge: ±8KV, 10times Contact discharge: ±4KV, 10times				
Remark : 1.The test samples should be applied to only one test item. 2.Sample size for each test item is 3~5pcs. 3.For High temperature high humidity test, Pure water(Resistance>10MΩ) should be used. 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part. 5.B/L evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence B/L has. 6.Failure judgment criterion: Basic specification, Electrical characteristic, Mechanical characteristic, Optical characteristic. 7.After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.				

12. INSPECTION CRITERION

Refer to the quality standard on the back of the specification

13. HANDLING PRECAUTIONS

13.1 Mounting method

The LCD module consists of two thin glass plates with polarizers which easily be damaged. And since the module is so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

13.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent [recommended below] and wipe lightly :

- .Isopropyl alcohol
- .Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent :

- .Water
- .Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns

Do not use the following solvent on the pad or prevent it from being contaminated :

- .Soldering flux
- .Chlorine (Cl) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happens by miss-handling or using some materials such as Chlorine (Cl), Sulfur (S) from customer, Responsibility is on customer.

13.3 Caution against static charge

The LCD module uses C-MOS LSI drivers, so we recommend that you :

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

13.4 Packing

Module employs LCD elements and must be treated as such.

- .Avoid intense shock and falls from a height.
- .To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity.

13.5 Caution for operation

- .It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage than the limit causes the shorter LCD life.
- .An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- .Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- .If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- .A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
- .Usage under the maximum operating temperature, 50%Rh or less is required.
- .When fixed patterns are displayed for a long time, remnant image is likely to occur.

13.6 Storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- .Storing in an ambient temperature 10°C to 30°C, and in a relative humidity of 45% to 75%. Don't expose to sunlight or fluorescent light.
- .Storing in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it . And with no desiccant.
- .Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- .Storing with no touch on polarizer surface by anything else.

It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

13.7 Safety

- .It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- .When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

14. PRECAUTION FOR USE

14.1 A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

14.2 On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- .When a question is arisen in this specification.
- .When a new problem is arisen which is not specified in this specifications.
- .When an inspection specifications change or operating condition change in customer is reported to ODNA, and some problem is arisen in this specification due to the change.
- .When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

15. PACKING SPECIFICATION

Please consult our technical department for detail information.

16. HSF COMPLIANCE

- .This products complies with ROHS 2011/65/EU and 2015/863/EU、REACH 1907/2006/EC requirements, and the packaging complies with 94-62-EC.